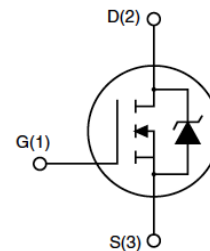


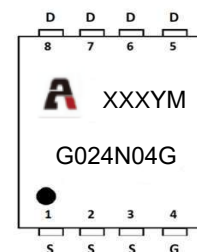
Feature

- 40V,120A
 $R_{DS(ON)}$ (TYP: $2.0m\Omega$) $< 2.4m\Omega$ @ $V_{GS}=10V$
 $R_{DS(ON)}$ (TYP: $3.0m\Omega$) $< 3.6m\Omega$ @ $V_{GS}=4.5V$
- Split Gate Trench Technology
- Lead free product is acquired
- Excellent $R_{DS(ON)}$ and Low Gate Charge



Application

- PWM applications
- Load Switch
- Power management



Marking and pin Assignment

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
G024N04G	APG024N04G	PDFN5X6	13 inch	-	5000

ABSOLUTE MAXIMUM RATINGS ($T_J=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_c = 25^{\circ}C$)	I_D	120	A
Continuous Drain Current ($T_c = 100^{\circ}C$)	I_D	74	A
Pulsed Drain Current ⁽¹⁾	I_{DM}	468	A
Single Pulsed Avalanche Energy ⁽²⁾	E_{AS}	144	mJ
Power Dissipation	P_D	62.5	W
Thermal Resistance from Junction to Case	$R_{\theta JC}$	2	$^{\circ}C/W$
Thermal Resistance- Junction to Ambient ⁽³⁾	$R_{\theta JA}$	65	$^{\circ}C/W$
Junction Temperature	T_J	150	$^{\circ}C$
Storage Temperature	T_{STG}	-55~ +150	$^{\circ}C$

MOSFET ELECTRICAL CHARACTERISTICS(T_J=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	40	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =40V, V _{GS} = 0V	-	-	1	μA
Gate-body leakage current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.2	1.7	2.2	V
Drain-source on-resistance	R _{DS(on)}	V _{GS} =10V, I _D =30A	-	2.0	2.4	mΩ
		V _{GS} =4.5V, I _D =20A	-	3.0	3.6	
Gate Resistance	R _g	V _{DS} =V _{GS} =0V, f =1MHz	-	6.5	-	Ω
Dynamic characteristics						
Input Capacitance	C _{iSS}	V _{DS} =20V, V _{GS} =0V, f =1MHz	-	1827	-	pF
Output Capacitance	C _{oSS}		-	623	-	
Reverse Transfer Capacitance	C _{rSS}		-	22	-	
Switching characteristics						
Turn-on delay time	t _{d(on)}	V _{DD} =20V, I _D =20A, V _{GS} =10V, R _G =6Ω	-	6.2	-	ns
Turn-on rise time	t _r		-	27.4	-	
Turn-off delay time	t _{d(off)}		-	39.8	-	
Turn-off fall time	t _f		-	16.6	-	
Total Gate Charge	Q _g	V _D S=20V, I _D =20A, V _G S=10V	-	28.3	-	nC
Gate-Source Charge	Q _{gs}		-	6.17	-	
Gate-Drain Charge	Q _{gd}		-	4.55	-	
Reverse Recovery Chrage	Q _{rr}	I _F =20A, di/dt=100A/us		20		nC
Reverse Recovery Time	T _{rr}	I _F =20A, di/dt=100A/us		36		ns
Source-Drain Diode characteristics						
Diode Forward voltage	V _{SD}	V _{GS} =0V, I _S =50A	-	-	1.2	V
Diode Forward current	I _S		-	-	80	A

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition: T_J=25°C, V_{DD}=20V, I_{AS}=24A, R_G=25Ω, L=0.5mH
3. The value of R_{θJA} Mounted on FR4 Board (2 5.4mm*25.4mm*t1.6mm) With 2oz Copper , T_a=25°C

Test circuits and waveforms

Figure A: Gate Charge Test Circuit & Waveforms

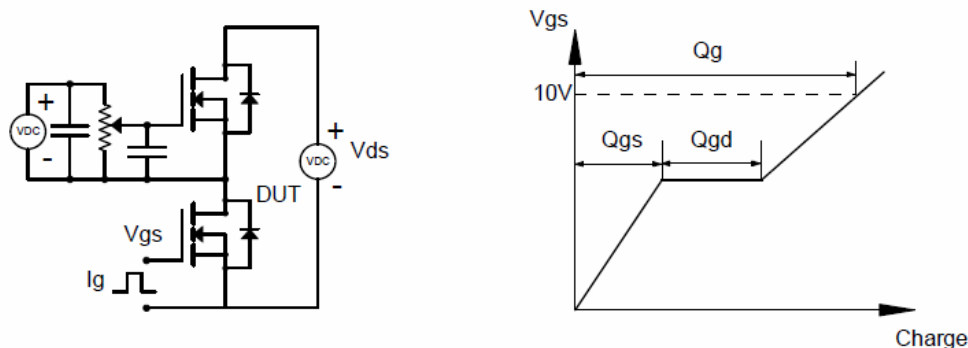


Figure B: Resistive Switching Test Circuit & Waveforms

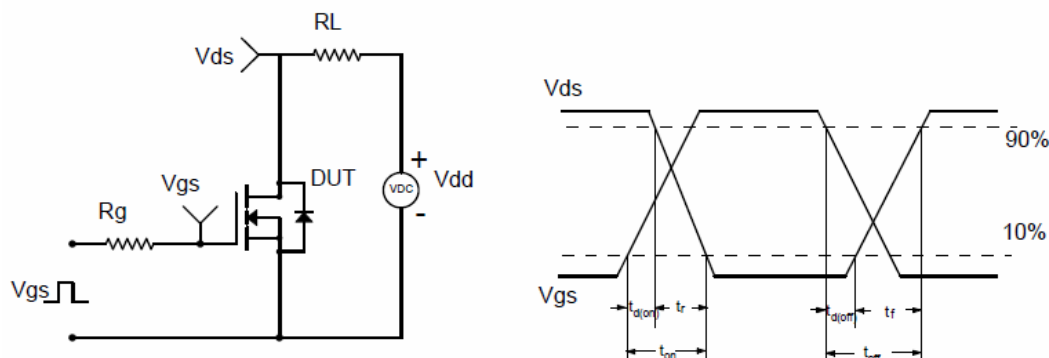


Figure C: Unclamped Inductive Switching (UIS) Test

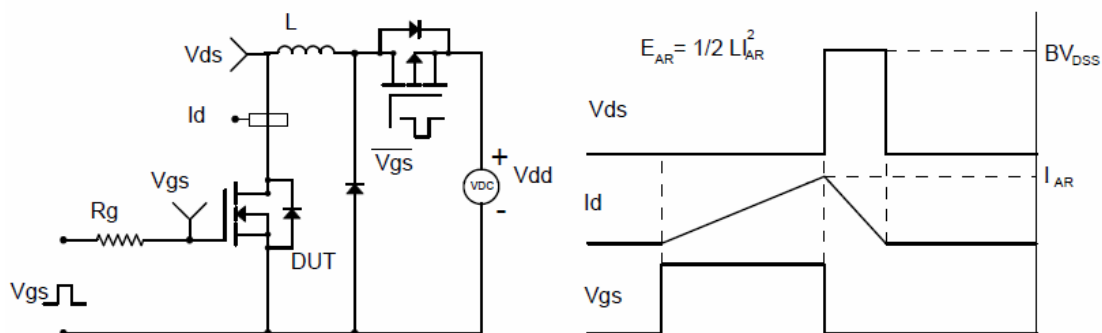
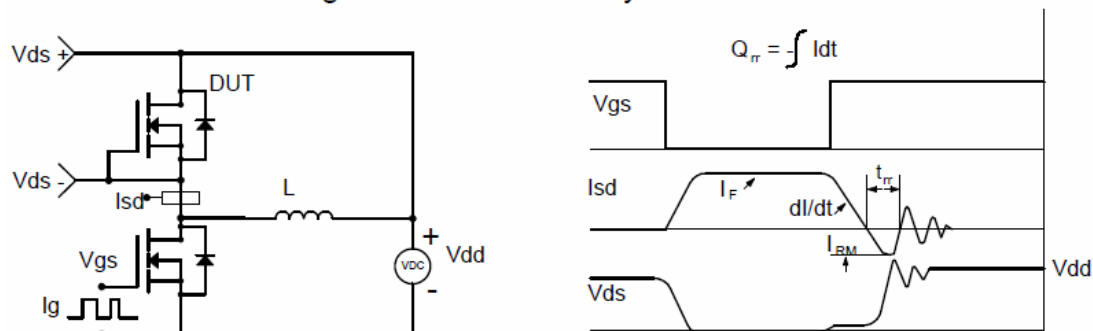


Figure D: Diode Recovery Test Circuit & Waveforms



Electrical Characteristics Diagrams

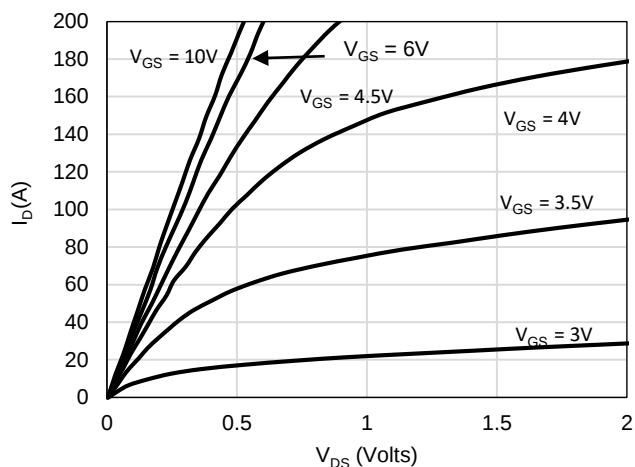


Figure 1: On-Region Characteristics

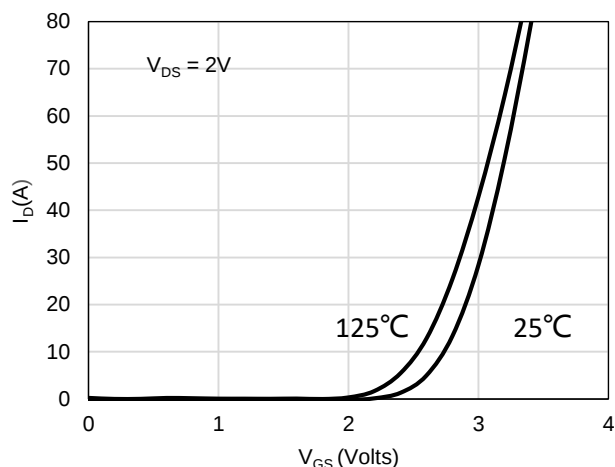


Figure 2: Transfer Characteristics

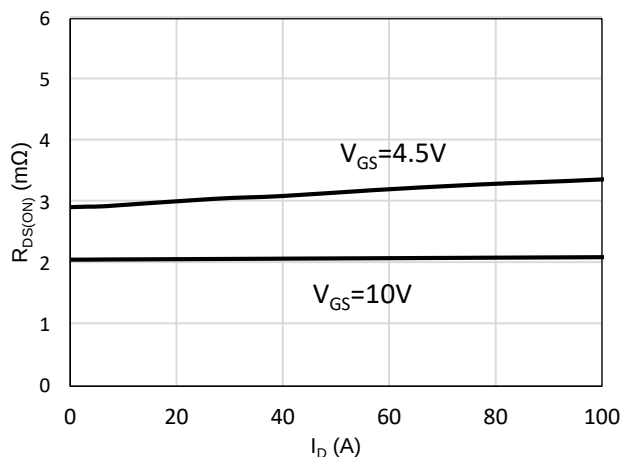


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

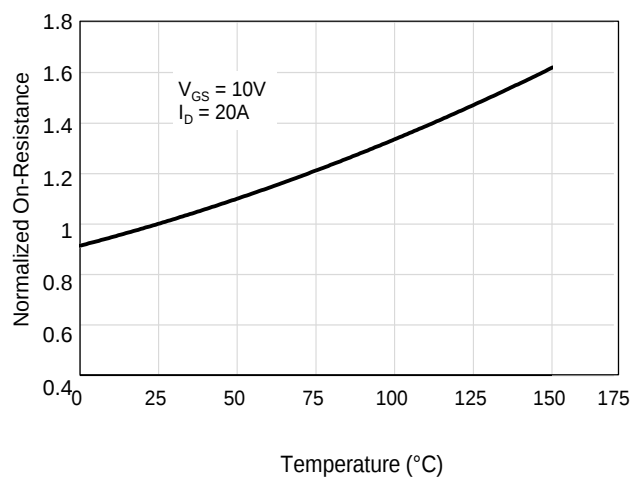


Figure 4: On-Resistance vs. Junction Temperature

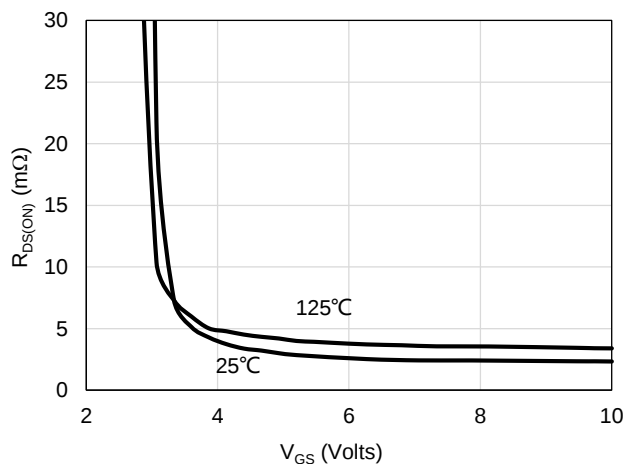


Figure 5: On-Resistance vs. Gate-Source Voltage

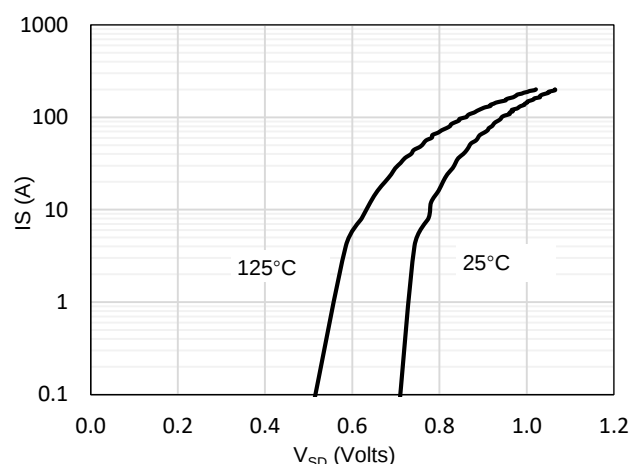
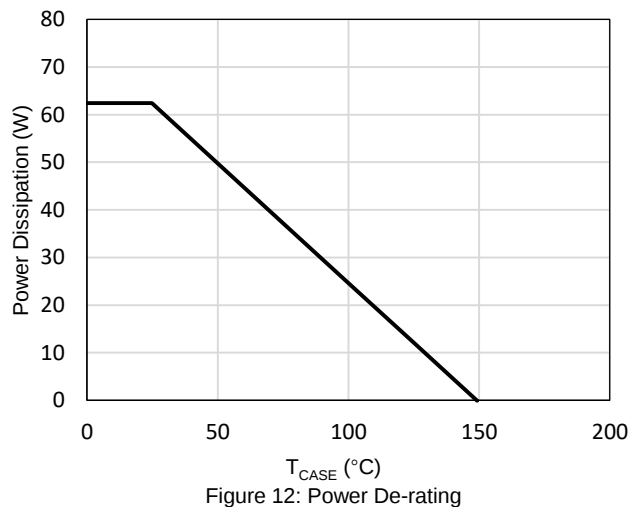
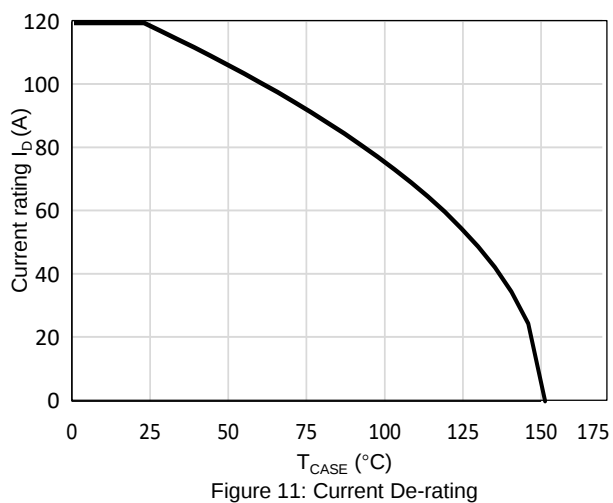
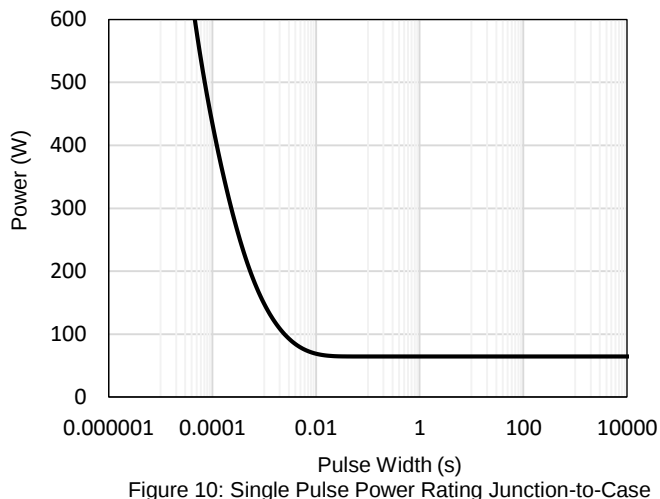
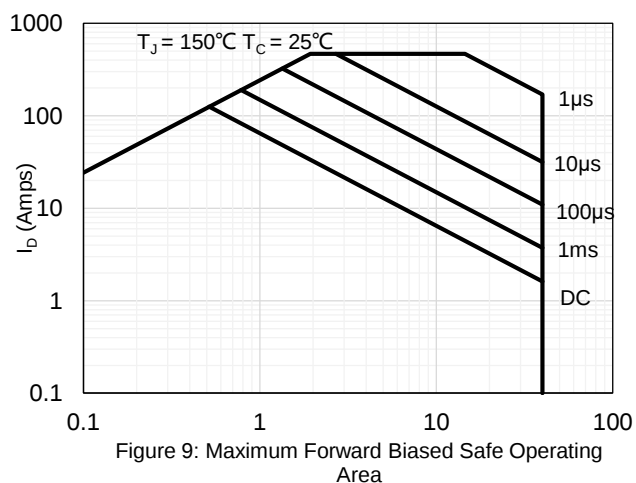
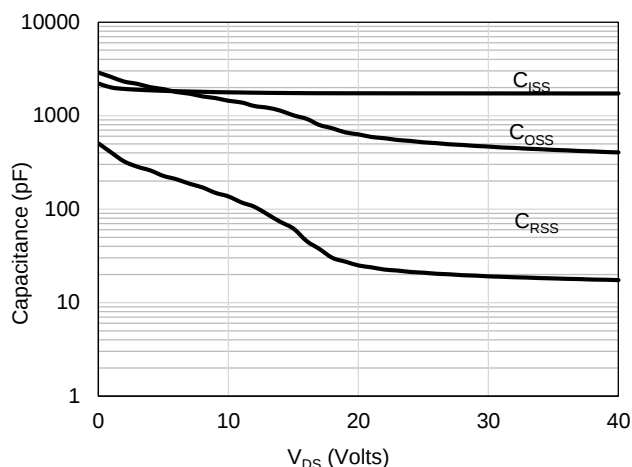
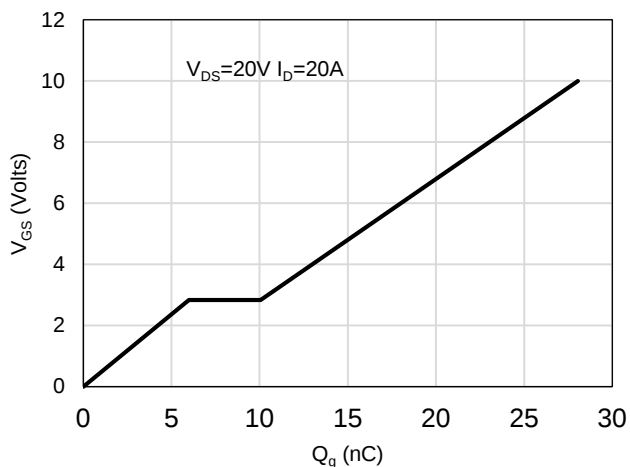
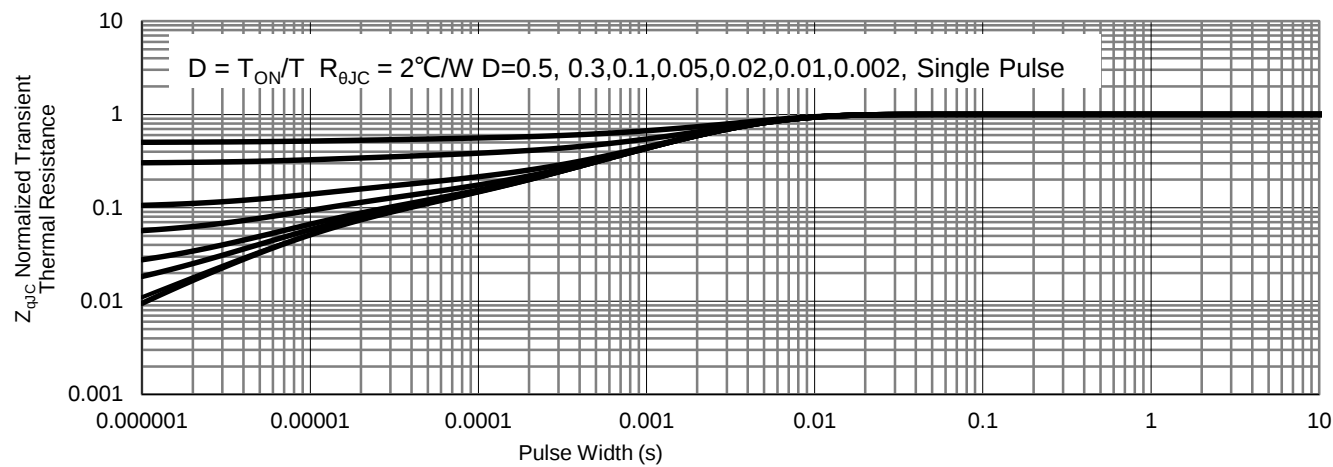


Figure 6: Body-Diode Characteristics

Electrical Characteristics Diagrams

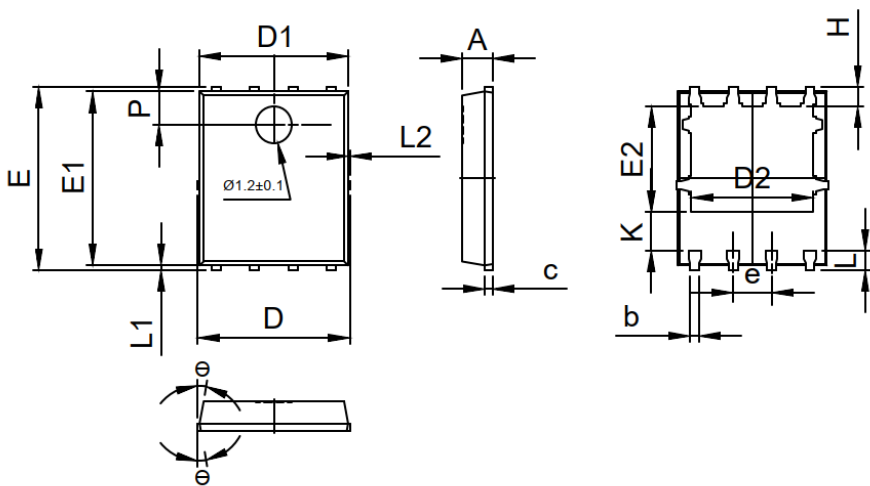


Electrical Characteristics Diagrams



PDFN5X6 Package Information

COMMON DIMENSIONS
(UNITS OF MEASURE = MILLIMETER)



SYMBOL	MIN	NOM	MAX
A	0.90	1.00	1.10
b	0.25	0.30	0.35
c	0.21	0.25	0.34
D	—	—	5.10
D1	4.80	4.90	5.00
D2	3.91	4.01	4.11
e	1.27 BSC		
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.375	3.475	3.575
H	0.55	0.65	0.75
K	1.20	—	—
L	0.55	0.65	0.75
L1	0.05	0.15	0.25
L2	—	—	0.12
θ	8°	10°	12°
P	1.00	1.10	1.20

Revision History

Revision	Release	Remark
V1.0	2023/11/10	Initial Release
V1.1	2025/08/01	Added Marking instructions

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Allpower assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.